

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4111014

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	SILICON GRAPHICS, INC.	05/08/2009
RECEIVING PARTY DATA		
Name:	SILICON GRAPHICS INTERNATIONAL, INC.	
Street Address:	900 NORTH MCCARTHY BLVD	
City:	MILPITAS	
State/Country:	CALIFORNIA	
Postal Code:	95035	
PROPERTY NUMBERS Total: 5		
Property Type	Number	
Application Number:	11295676	
Application Number:	15219797	
Application Number:	14987690	
Application Number:	15051512	
Application Number:	11386382	
CORRESPONDENCE DATA		
Fax Number:		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	415-248-2120	
Email:	tpham@polsinelli.com	
Correspondent Name:	POLSINELLI LLP	
Address Line 1:	3 EMBARCADERO CENTER	
Address Line 2:	1350	
Address Line 4:	SAN FRANCISCO, CALIFORNIA 94111	
ATTORNEY DOCKET NUMBER:	SGI ASSIGNMENT	
NAME OF SUBMITTER:	MIYA YUSA	
SIGNATURE:	/Miya Yusa/	
DATE SIGNED:	10/24/2016	
Total Attachments: 58		

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BILL OF SALE AND ASSIGNMENT AGREEMENT

FOR VALUE RECEIVED, and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged on this 8th day of May, 2009 ("Effective Date"), Silicon Graphics, Inc., Silicon Graphics Real Estate, Inc., Silicon Graphics World Trade Corporation, ParaGraph International, Inc., WTI Development, Inc., Silicon Studio, Inc., Silicon Graphics of Manhattan, Inc., Cray Research, L.L.C., Cray Financial Corp., Cray Research America Latina Ltd., Cray Research (Eastern Europe) Ltd., Cray Research (India) Ltd., Cray Asia/Pacific, Inc. and Cray Research International Inc. on the one hand (collectively, the "Selling Entities") do hereby sell, assign, transfer, convey and deliver to Silicon Graphics International, Inc., a Delaware corporation (the "Buyer") on the other hand, all of Selling Entities' right, title and interest in and to all of the Purchased Assets as defined in that certain Asset Purchase Agreement by and among the Selling Entities and the Buyer dated March 31, 2009, as amended on April 30, 2009 (the "Purchase Agreement") except as set forth in Exhibit A hereto. Capitalized terms used without definitions herein shall have the meanings ascribed to such terms in the Purchase Agreement.

1. Assignment of Purchased Assets. In accordance with and subject to the terms and conditions set forth in the Purchase Agreement, the Selling Entities hereby sell, assign, convey, transfer and deliver unto Buyer all of their right, title and interest in and to the Purchased Assets, as described and other than as set forth in Exhibit A, free and clear of all Encumbrances (other than Permitted Encumbrances and subject to any order entered by the Bankruptcy Court as of the date hereof resolving any previously filed objection to the assumption and assignment of executory contracts and unexpired leases of nonresidential real property and/or proposed cure amount) as provided in the Purchase Agreement and the Sale Order; *provided* that the Selling Entities do not assume and assign unto Buyer any executory contract or unexpired lease of nonresidential property that is subject to any objections to the assumption and assignment thereof and/or proposed cure amount that have not been resolved as of the date hereof. Buyer hereby accepts such assignment. The parties acknowledge that title to and possession of such assets will pass in the jurisdiction where such assets are located, regardless of the jurisdiction in which this Bill of Sale and Assignment Agreement, or any other agreement, is executed.

2. Assumed Agreements. The Selling Entities, pursuant to the Asset Purchase Agreement and the Sale Order, hereby sell, assign, convey and transfer to Buyer all of their right, title and interest in and to the Assumed Agreements identified in Exhibit B to this Bill of Sale and Assignment Agreement free and clear of all Encumbrances (other than Permitted Encumbrances and subject to any order entered by the Bankruptcy Court as of the date hereof resolving any previously filed objection to the assumption and assignment of executory contracts and unexpired leases of nonresidential real property and/or proposed cure amount); *provided* that the Selling Entities do not assume and assign unto Buyer any executory contract or unexpired lease of nonresidential property that is subject to any objections to the assumption and assignment thereof and/or proposed cure amount that have not been resolved as of the date hereof. Buyer hereby accepts such assignment.

3. No Liabilities Assumed. Buyer does not assume and is not obligated to pay, perform or otherwise discharge any Liabilities of the Selling Entities or their Affiliates other than the Assumed Liabilities pursuant to the Purchase Agreement and the Assumption Agreement.

4. Construction. The terms "hereby," "hereto," "hereunder" and any similar terms as used in this Bill of Sale and Assignment Agreement, refer to this Bill of Sale and Assignment Agreement in its entirety and not only to the particular portion of this Bill of Sale and Assignment Agreement where the term is used. The term "including," when used herein without the qualifier, "without limitation," shall mean "including, without limitation." Wherever in this Bill of Sale and Assignment Agreement the singular number is used, the same shall include the plural, and the masculine gender shall include the feminine and neuter genders, and vice versa, as the context shall require. The word "or" shall not be construed to be exclusive. Provisions shall apply, when appropriate, to successive events and transactions. Unless otherwise indicated, references to Schedules and Exhibits refer to Schedules and Exhibits of and to this Bill of Sale and Assignment Agreement.

5. Purchase Agreement Controls. To the extent any terms and provisions of this Bill of Sale and Assignment Agreement are inconsistent with or in conflict with any term, condition or provision of the terms and provisions of the Purchase Agreement, the terms of the Purchase Agreement shall govern and control.

6. Governing Law. This Bill of Sale and Assignment Agreement shall be governed by the laws of the State of New York, without giving effect to the principles of conflicts of laws thereof.

7. Counterparts. This Bill of Sale and Assignment Agreement may be executed and delivered (including by facsimile transmission) in one or more counterparts, and by the different parties hereto in separate counterparts, each of which, when executed and delivered, shall be deemed to be an original but all of which taken together shall constitute one and the same agreement.

[SIGNATURE PAGE FOLLOWS]

IN WITNESS WHEREOF, the parties hereto have executed and entered into this Bill of Sale and Assignment Agreement effective as of the Effective Date.

Silicon Graphics, Inc. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____	
Silicon Graphics Real Estate, Inc. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____	ParaGraph International, Inc. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____
Silicon Graphics World Trade Corporation Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____	WTT Development, Inc. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____
Silicon Graphics of Manhattan, Inc. Debtor and Debtor In Possession By: _____ Name: _____ Its: _____	Silicon Studio, Inc. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____

Signature Page to Bill of Sale and Assignment Agreement

Cray Financial Corp. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____	Cray Research, L.L.C. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____
Cray Research (Eastern Europe) Ltd. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____	Cray Research Americas Latina Ltd. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____
Cray Asia/Pacific, Inc. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____	Cray Research (India) Ltd. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____
	Cray Research International Inc. Debtor and Debtor In Possession By: <u>[Signature]</u> Name: _____ Its: _____

Signatures Page to Bill of Sale and Assignment Agreement.

IN WITNESS WHEREOF, the parties hereto have executed and entered into this Bill of Sale and Assignment Agreement effective as of the Effective Date.

Agreed and Accepted

SILICON GRAPHICS INTERNATIONAL, INC.

By:

James Wheat

Name:

JAMES WHEAT

Its:

Chief financial officer

[Exhibits and Schedules have been redacted from this document.]

ASSET PURCHASE AGREEMENT

BY AND AMONG

SILICON GRAPHICS, INC.

**EACH OF THE SUBSIDIARIES OF SILICON GRAPHICS, INC.
LISTED ON SCHEDULE I**

AND

RACKABLE SYSTEMS, INC.

DATED AS OF MARCH 31, 2009

SCHEDULES

Schedule 2.1(f)

Specified IP

ASSET PURCHASE AGREEMENT

This Asset Purchase Agreement (this "Agreement") is made and entered into as of this 31st day of March, 2009 by and among SILICON GRAPHICS, INC., a Delaware corporation (the "Seller") and each of the subsidiaries of the Seller listed on Schedule I (together with the Seller, the "Selling Entities"), and RACKABLE SYSTEMS, INC. a Delaware corporation (the "Buyer").

WHEREAS, the Selling Entities are preparing to file Chapter 11 bankruptcy petitions pursuant to Title 11 of the United States Code, 11 U.S.C. § 101, et seq. (collectively, the "Bankruptcy Case"); and

WHEREAS, the Buyer desires to purchase (directly and/or, in the Buyer's sole discretion, through an affiliate of the Buyer (a "Buyer Affiliate")) from the Selling Entities, and the Selling Entities desire to sell to the Buyer and/or (in the Buyer's sole discretion) a Buyer Affiliate, certain of the Selling Entities' assets free and clear of Encumbrances (as defined below) except for Permitted Encumbrances (as defined below), and to assume from the Selling Entities certain specified liabilities pursuant to the terms and subject to the conditions set forth herein.

NOW, THEREFORE, in consideration of the mutual covenants, representations, warranties and agreements hereinafter set forth, and intending to be legally bound hereby, the parties hereto agree as follows:

ARTICLE I DEFINITIONS

[This page has been redacted from this document.]

"Encumbrances" means any charge, lien (statutory or otherwise), mortgage, lease, hypothecation, encumbrance, pledge, security interest, option, right of use, first offer or first refusal, easement, servitude, restrictive covenant, encroachment, Claim, conditional or installment sale agreement, use or transfer limitation, equitable interest or similar restriction; *provided, however*, that Assumed Liabilities shall not constitute Encumbrances.

"Intellectual Property" means algorithms, APIs, apparatus, designs, net lists, databases, data collections, diagrams, inventions (whether or not patentable), know-how, logos, marks (including brand names, product names, logos, and slogans), circuit designed assemblies, semiconductor devices, net lists, IP cores, photo masks, test vectors, methods, network configurations and architectures, processes, proprietary information, protocols, schematics, specifications, software, software code (in any form, including source code and executable or object code), subroutines, techniques, user interfaces, URLs, web sites, works of authorship and other forms of technology (whether or not embodied in any tangible form and including all tangible embodiments of the foregoing, such as instruction manuals, laboratory notebooks, prototypes, samples, studies and summaries).

"Intellectual Property Rights" means all rights of the following types, which may exist or be created under the laws of any jurisdiction in the world: (i) rights associated with works of authorship, including exclusive exploitation rights, mask work rights, copyrights and moral rights; (ii) trademark and trade name rights and similar rights; (iii) trade secret rights; (iv) patents and industrial property rights; (v) other proprietary rights in Intellectual Property; and (vi) rights in or relating to registrations, renewals, extensions, combinations, divisions, and reissues of, and applications for, any of the rights referred to in clauses "(i)" through "(v)" above.

"Licensed Intellectual Property" means all Intellectual Property and Intellectual Property Rights licensed to the Selling Entities pursuant to the Assumed Agreements.

"Permitted Encumbrances" means: (a) statutory liens for current Taxes, special assessments or other governmental charges not yet due and payable; (b) mechanics', materialmens', carriers', workers', repairers' and similar statutory liens arising or incurred in the ordinary course of business which liens are not reasonably likely to materially interfere with the use or value of the Purchased Assets as a whole; (c)

zoning, entitlement, building and other land use by-laws, ordinances or regulations imposed by Governmental Authorities having jurisdiction over any Owned Real Property which are not violated in any material respect by the current occupancy, use and operation of the Owned Real Property; (d) covenants, conditions, restrictions, easements, title imperfections and other similar encumbrances affecting title to the Owned Real Property, other than contracts that secure monetary liens, that do not adversely affect the current occupancy, use, operation or value of the Owned Real Property in any material respect; (e) all matters that would be disclosed on an accurate current survey of the Owned Real Property that would not adversely affect the current occupancy, use, operation or value of the Owned Real Property in any material respect, (f) statutory liens creating a security interest in favor of landlords under leases which do not interfere with the Selling Entities' current use of, or affect the value of, any material Purchased Asset, in either case, in any material respect; (g) Encumbrances on any of the Purchased Assets which do not materially and adversely interfere with the Selling Entities' current use of, or materially and adversely affect the value of, the Purchased Assets, taken as a whole; (h) Encumbrances contained in the Assumed Agreements; (i) Encumbrances arising from applicable laws of general application which do not interfere with the Selling Entities' current use of, or affect the value of, any material Purchased Asset, in either case, in any material respect; and (j) the Encumbrances disclosed as items 1 through 5 in Schedule 5.3(a).

"Registered IP" means all Specified IP that, as of the date of this Agreement, is registered, filed or issued under the authority of, with or by any Governmental Authority in the United States of America, including all patents, registered copyrights, registered mask works and registered trademarks and all applications for any of the foregoing.

"Specified IP" means all Intellectual Property and Intellectual Property Rights (including the goodwill of the Selling Entities) owned by the Selling Entities as of the Closing (including the right to use the name Silicon Graphics, SGI and other trade names included in the Purchased Assets and including the Intellectual Property listed on Schedule 2.1(f) but excluding the Excluded Patents), and all right, title and interest of the Selling Entities in the Licensed Intellectual Property.

[This page has been redacted from this document.]

ARTICLE II PURCHASE AND SALE

Section 2.1 Purchase and Sale of Assets. Upon the terms and subject to the satisfaction of the conditions contained in this Agreement, at the Closing, the Selling Entities shall sell, assign, convey, transfer and deliver to the Buyer and/or (in the Buyer's sole discretion) a Buyer Affiliate, and the Buyer and/or (in the Buyer's sole discretion) a Buyer Affiliate shall, by the Buyer's payment of the Purchase Price, purchase and acquire from the Selling Entities, all of the Selling Entities' right, title and interest, free and clear of all Encumbrances (other than Permitted Encumbrances), in and to all of the properties, rights, interests and other tangible and intangible assets of the Selling Entities (wherever located and whether or not required to be reflected on a balance sheet prepared in accordance with generally accepted accounting principles), including any assets acquired by the Selling Entities after the date hereof but prior to the Closing; *provided, however*, that: (A) the Purchased Assets shall not include any Excluded Assets; and (B) from and after the date hereof until Closing, the Buyer may designate, in its sole discretion, any asset or assets that would otherwise be Purchased Assets as Excluded Assets by providing written notice of such designation to the Seller, in which case Schedule 2.2 shall be deemed to be amended accordingly. Without limiting the generality of the foregoing, the Purchased Assets shall include the following (except to the extent listed or otherwise included as an Excluded Asset):

(f) all Specified IP;

[Pages 9 to 37 have been redacted from this document.]

IN WITNESS WHEREOF, the parties hereto have caused this Agreement to be executed as of the date first above written by their respective officers thereunto duly authorized.

RACKABLE SYSTEMS, INC.

By: Mark Barrenechea
Name: Mark Barrenechea
Title: President and Chief Executive Officer

IN WITNESS WHEREOF, the parties hereto have caused this Agreement to be executed as of the date first above written by their respective officers thereunto duly authorized.

SILICON GRAPHICS, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

SILICON GRAPHICS REAL ESTATE, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

SILICON GRAPHICS WORLD TRADE
CORPORATION

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

SILICON GRAPHICS FEDERAL, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

PARAGRAPH INTERNATIONAL, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

WTI DEVELOPMENT, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

SILICON STUDIO, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

SILICON GRAPHICS OF MANHATTAN, INC.

By: [Signature]
Name: Diane Gibson
Title: President

CRAY RESEARCH, L.L.C.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

CRAY FINANCIAL CORP.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

CRAY RESEARCH AMERICA LATINA LTD.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

CRAY RESEARCH (EASTERN EUROPE) LTD.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

CRAY RESEARCH (INDIA) LTD.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

CRAY ASIA/PACIFIC, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

CRAY RESEARCH INTERNATIONAL INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

[Exhibits have been redacted from this document.]

AMENDMENT TO ASSET PURCHASE AGREEMENT

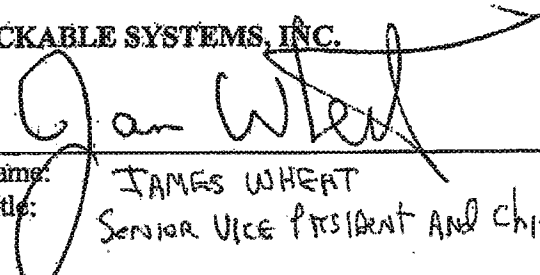
This Amendment (this "Amendment") to the Asset Purchase Agreement (the "Asset Purchase Agreement") by and among SILICON GRAPHICS, INC., a Delaware corporation (the "Seller") and each of the subsidiaries of the Seller listed on Schedule I thereto (together with the Seller, the "Selling Entities"), and RACKABLE SYSTEMS, INC. a Delaware corporation (the "Buyer") dated as of March 31, 2009, is being entered into as of April 30, 2009, among the Seller, the Selling Entities and the Buyer in accordance with Section 10.1 of the Asset Purchase Agreement. All capitalized terms used but not otherwise defined in this Amendment have the meanings given to them in the Asset Purchase Agreement. The Asset Purchase Agreement is hereby amended as follows:

3. Schedule 2.1(f) to the Asset Purchase Agreement is amended and restated and is attached as Exhibit 1 to this Amendment.

[The following 5 pages of the Amendment to Asset Purchase Agreement have been redacted from this document.]

IN WITNESS WHEREOF, the parties hereto have caused this Amendment to be executed as of the date first above written by their respective officers thereunto duly authorized.

RACKABLE SYSTEMS, INC.

By: 

Name:

JAMES WHEAT

Title:

SENIOR VICE PRESIDENT AND CHIEF FINANCIAL OFFICER

PATENT

REEL: 030205 FRAME: 0466

IN WITNESS WHEREOF, the parties hereto have caused this Amendment to be executed as of the date first above written by their respective officers thereunto duly authorized.

SILICON GRAPHICS, INC.

By: [Signature]
Name: Greg Wood
Title: CFO

SILICON GRAPHICS REAL ESTATE, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

SILICON GRAPHICS WORLD TRADE CORPORATION

By: [Signature]
Name: Greg Wood
Title: Director Chief Financial Officer

SILICON GRAPHICS FEDERAL, INC.

By: _____
Name: _____
Title: _____

PARAGRAPH INTERNATIONAL, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

WTI DEVELOPMENT, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

IN WITNESS WHEREOF, the parties hereto have caused this Amendment to be executed as of the date first above written by their respective officers thereunto duly authorized.

SILICON GRAPHICS, INC.

By: _____
Name: _____
Title: _____

SILICON GRAPHICS REAL ESTATE, INC.

By: _____
Name: _____
Title: _____

SILICON GRAPHICS WORLD TRADE CORPORATION

By: _____
Name: _____
Title: _____

SILICON GRAPHICS FEDERAL, INC.

By: *Karl Randolph* _____
Name: *Karl Randolph*
Title: *Secretary*

PARAGRAPH INTERNATIONAL, INC.

By: _____
Name: _____
Title: _____

WTI DEVELOPMENT, INC.

By: _____
Name: _____
Title: _____

SILICON STUDIO, INC.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

SILICON GRAPHICS OF MANHATTAN, INC.

By: [Signature]
Name: Diane Gibson
Title: President

CRAY RESEARCH, L.L.C.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

CRAY FINANCIAL CORP.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

CRAY RESEARCH AMERICA LATINA LTD.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

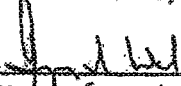
CRAY RESEARCH (EASTERN EUROPE)
LTD.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

CRAY RESEARCH (INDIA) LTD.

By: [Signature]
Name: Greg Wood
Title: Chief Financial Officer

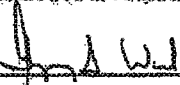
CRAY ASIA/PACIFIC, INC.

By: 

Name: Greg Wood

Title: Chief Financial Officer

CRAY RESEARCH INTERNATIONAL INC.

By: 

Name: Greg Wood

Title: Chief Financial Officer

PATENT

REEL: 030205 FRAME: 0460

EXHIBIT 1

AMENDED AND RESTATED SCHEDULE 2.1(f)

SPECIFIED IP

See attached.

EXHIBIT 1

AMENDED AND RESTATED SCHEDULE 2.1(f)

SPECIFIED IP

See attached.

Schedule 2.1(f)

2.1(f)

US Patents and Patent Applications

Country InvTitle

PatNumber

[The following 18 pages of Schedule 2.1f have been redacted from this document.]

Schedule 2.1(f)

09/549,980

CAMABLE, BLIND
MATE/DEMATE OPTICAL EDGE
CONNECTOR

US

Schedule 2.1(f)

MULTIPROCESSOR SYSTEM
AND METHOD OF ACCESSING
DATA THEREIN

US

10/696,146

[The following 2 pages of Schedule 2.1f have been redacted from this document.]

Schedule 2.1(f)

12/247, 122

SYSTEM AND METHOD FOR
ADAPTIVELY DESKEWING
PARALLEL DATA SIGNALS
RELATIVE TO A CLOCK

US

[The following 2 pages of Schedule 2.1f have been redacted from this document.]

Schedule 2.1(f)

12/18/2002

MULTIPROCESSOR NODE
CONTROLLER CIRCUIT AND
METHOD

US

Schedule 2.1(f)

NETWORK TOPOLOGY FOR A
SCALABLE MULTIPROCESSOR
SYSTEM

US

12/121,941

[The following 2 pages of Schedule 2.1f have been redacted from this document.]

Schedule 2.1(f)

SYSTEM, METHOD, AND
COMPUTER PROGRAM
PRODUCT FOR REMOTE
GRAPHICS PROCESSING

US

11/892,627

Schedule 2.1(f)

MAINTAINING MEMBERSHIP IN
HIGH AVAILABILITY
COMPUTING SYSTEMS

US

09/811,158

SYSTEM AND METHOD FOR
RETROFITTING A PROCESSOR
INTO A SYSTEM DESIGNED
FOR ANOTHER PROCESSOR

US

09/648,150

ADDRESS-SELECTED
ATTRIBUTE ENCODING AND
BYTE-SWAPPING

US

09/648,902

Schedule 2.1(f)

SYSTEM AND METHOD FOR
REMOVING DATA FROM
PROCESSOR CACHES IN A
DISTRIBUTED
MULTIPROCESSOR COMPUTER
SYSTEM

US

09/909,700

[The following 2 pages of Schedule 2.1f have been redacted from this document.]

Schedule 2.1(f)

FLEXIBLE FAILOVER POLICIES
IN HIGH AVAILABILITY
COMPUTING SYSTEMS

US

09/997,404

Schedule 2.1(f)

APPARATUS AND METHOD FOR
CONTROLLING THE FLOW AND
ORDERING OF DATA
TRANSFERRED OVER
MULTIPLE CHANNELS

US

12/273,453

Schedule 2.1(f)

US	MEMBERSHIP VERSION SUPPORT	11/785,255
US	INTERRUPTIBLE TOKEN ACQUISITION	11/785,256
US	RELOCATION OF METADATA SERVER WITH OUTSTANDING DMAPI REQUESTS	10/620,387
US	RECOVERY AND RELOCATION OF A DISTRIBUTED NAME SERVICE IN A CLUSTERED FILE SYSTEM	10/345,357
US	FAILURE HIERARCHY IN A CLUSTER FILESYSTEM	10/345,371
US	MESSAGING BETWEEN HETEROGENEOUS CLIENTS OF A STORAGE AREA NETWORK	10/414,245

Schedule 2.1(f)

CLUSTERED FILESYSTEM FOR
MIX OF TRUSTED AND
UNTRUSTED NODES

10/414,239

US

MULTI-CLASS
HETEROGENEOUS CLIENTS IN
A CLUSTERED FILESYSTEM

10/414,236

US

Schedule 2.1(f)

SYSTEM, METHOD, AND
COMPUTER PROGRAM
PRODUCT FOR APPLYING
DIFFERENT TRANSPORT
MECHANISMS FOR USER
INTERFACE AND IMAGE
PORTIONS OF A REMOTELY
RENDERED IMAGE

US

10/426,003

Schedule 2.1(f)

10 / 310, 237

SYSTEM AND METHOD FOR
CONVEYING INFORMATION

US

11 / 585, 619

OPTIMIZING COMPUTATIONAL
DENSITY IN HPC SYSTEMS

US

10 / 434, 340

REAL-TIME STORAGE AREA
NETWORK

US

Schedule 2.1(f)

12/264,871

METHOD AND SYSTEM FOR
CONVEYING INFORMATION

US

10/631,988

DETECTION AND CONTROL OF
RESOURCE CONGESTION BY A
NUMBER OF PROCESSORS

US

10/620,797

METHOD FOR EQUITABLE
RESOURCE SHARING BETWEEN
LOCAL AND NETWORK
FILESYSTEMS

US

Schedule 2.1(f)

NETWORK FILESYSTEM
ASYNCHRONOUS I/O
SCHEDULING

US

10/620,835

METHOD FOR PERFORMING
CACHE COHERENCY IN A
COMPUTER SYSTEM

US

10/837,057

Schedule 2.1(f)

US	SYSTEM AND METHOD FOR PERFORMING MEMORY OPERATIONS IN A COMPUTING SYSTEM	12/168,689
US	BUS WIDE PCI HOT-PLUG DESIGN	11/235,493
US	FAULT TOLERANT MEMORY SYSTEM	11/136,260
US	METHOD AND SYSTEM FOR CONTROLLING UTILISATION OF A FILE SYSTEM	10/912,722
US	CLUSTER FILESYSTEM	11/079,409
US	SYSTEM AND METHOD FOR SYNCHRONIZING DISTRIBUTION OF TRANSACTION OPERATIONS IN A COMPUTER SYSTEM	10/976,531
US	NODE SYNCHRONIZATION FOR A MULTI-PROCESSOR COMPUTER SYSTEMS	12/330,413

Schedule 2.1(f)

US	NEW SCALABLE DIRECTORY SCHEME FOR VERY LARGE SHARED MEMORY COMPUTER SYSTEMS	11/268,164
US	FAIL-SOFT CAPABILITY FOR MULTIPLE CPU SYSTEM GENERATION AND USE OF SYSTEM LEVEL DEFECT TABLES FOR MAIN MEMORY	11/334,526 11/323,029
US	A MECHANISM FOR MAINTAINING ACCURATE GLOBAL REAL TIME CLOCK IN ANY ARBITRARY DISTRIBUTED SYSTEM WITH DYNAMIC PARTITIONS AND UNRELIABLE NETWORKS	11/620,215
US	LOAD BALANCING FOR PARALLEL TASKS	11/677,460

Schedule 2.1(f)

US DIRECT MEMORY ACCESS
(DMA) ENGINE FOR DATA
TRANSFERS OF UNKNOWN
LENGTH 11/685,750

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A SCALABLE PARALLEL
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US

[The following 25 pages of Schedule 2.1f have been redacted from this document.]